



VANASETTI HEMANTH SAI RAJA

I am a hardworking and ambitious individual. I have excellent communication skills, enabling me to effectively communicate with a wide range of people. I am seeing a part-time position in the industry in which I can put into practice my knowledge and experience, ultimately benefiting the operations of the organisation that I work for.

Personal Info

Father's Name : V. N. Murthy
Date of Birth : 13-05-1997
Gender : Male
Hobbies : Reading Novels.
Nationality : Indian
Languages known : Telugu, Hindi, English.

Contact

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Balanagar, Hyderabad, 500042.

Major project :

To secure employment with a reputable company, where I can utilize my skills to the maximum DESIGN, ANALYSIS AND MANUFACATURING PROGRESSIVE DIE

The main moto of project is to reduce the cast of die and to improve mechanical properties of progressive die. Stage 1, Design & 2D layouts on CREO parametric 5.0. Stage 2, analysis in ANSYS workbench. Stage 3, Material use P20 Allloy. Which has high strength and toughness, available at low cost compared to HSS.

Education

ENGINEERING

| Jan 2016 - july 2020

- Completed Bachelor of Technology from Marri Laxman Reddy Institute Technology and Management (Hyderabad) with 72% in Mechanical engineering.

SCHOOLING

| Jan 2014 - May 2016

- Completed 10th & +2 CBSE with 86% From Sri Prakash Vidyaniketan (Visakhapatnam), with an aggregate of 86%.

Skills

• Ms office / Excel	<div></div>	55%
• Communication	<div></div>	70%
• Stress management	<div></div>	65%
• Creativity	<div></div>	60%
• C language	<div></div>	48%
• Basics of python	<div></div>	35%
• CAD software s	<div></div>	78%

Internship s

- I have done my summer internship in HINDUSTAN AERONOTICS LIMITED to understand the basic concepts
- Followed by CENTRAL INSTITUTE OF TOOL DESIGN to enhance designing skills.
- I have completed my major project as part of industrial visit in CIM Technologies.